

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Mahesh Sangneria et al.

SERIAL NO: 10/647,773) DATE: May 2, 2005
FILING DATE: August 25, 2003) GROUP ART UNIT: 2781
TITLE: METHOD OF) EXAMINER: Minh Loan Tran
IMPROVING
ADHESION
BETWEEN TWO
DIELECTRIC
FILMS

TRANSMITTAL OF FORMAL DRAWINGS**MAIL STOP ISSUE FEE**

Commissioner of Patents
P.O. Box 1450
Alexandria, VA 22313-1450

ATTN: OFFICIAL DRAFTSPERSON**CERTIFICATE OF MAILING UNDER 37 CFR 1.8**

I hereby certify that I am depositing the enclosed or attached correspondence with the United States Postal Service as first class mail in an envelope addressed to the, MAIL STOP ISSUE FEE, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 ATTN: OFFICIAL DRAFTSPERSON

on May 2, 2005

Carol M. Thomas

Name of person mailing paper

Signature

05/02/05

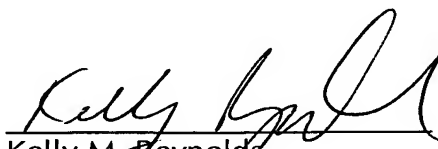
Date

Dear Sir:

Enclosed are formal drawings for the above-identified application. Kindly replace the informal drawings, as filed, with the enclosed drawings. No new matter has been added.

Please charge our Deposit Account No. **04-0566** for any fee relative to the acceptance of the attached formal drawings. A duplicate copy of this letter is enclosed for that purpose.

Respectfully submitted,



Kelly M. Reynolds
Reg. No. 47,898

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